

DATA SHEET

NEC

GaAs INTEGRATED CIRCUIT μ PG2409T6X

HIGH POWER SPDT SWITCH FOR WiMAX™

DESCRIPTION

The μ PG2409T6X is a GaAs MMIC high power SPDT (Single Pole Double Throw) switch which were designed for WiMAX.

This device can operate frequency from 0.05 to 6.0 GHz, having the low insertion loss and high isolation.

This device is housed in a 6-pin plastic TSON (Thin Small Out-line Non-leaded) (T6X) package. And this package is suitable for high-density surface mounting.

FEATURES

- Switch control voltage : $V_{\text{cont (H)}} = 3.0 \text{ V TYP.}$
: $V_{\text{cont (L)}} = 0 \text{ V TYP.}$
- Low insertion loss : $L_{\text{ins}} = 0.45 \text{ dB TYP. @ } f = 2.5 \text{ GHz}$
: $L_{\text{ins}} = 0.55 \text{ dB TYP. @ } f = 3.8 \text{ GHz}$
: $L_{\text{ins}} = 0.65 \text{ dB TYP. @ } f = 6.0 \text{ GHz}$
- High isolation : $ISL = 30 \text{ dB TYP. @ } f = 2.5 \text{ GHz}$
: $ISL = 30 \text{ dB TYP. @ } f = 3.8 \text{ GHz}$
: $ISL = 27 \text{ dB TYP. @ } f = 6.0 \text{ GHz}$
- Handling power : $P_{\text{in (1 dB)}} = +36.0 \text{ dBm TYP. @ } f = 0.05 \text{ to } 6.0 \text{ GHz}$
- High-density surface mounting : 6-pin plastic TSON (T6X) package (1.5 × 1.5 × 0.37 mm)

APPLICATIONS

- WiMAX and wireless LAN (IEEE802.11a/b/g/n)

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μ PG2409T6X-E2	μ PG2409T6X-E2-A	6-pin plastic TSON (T6X) (Pb-Free)	G5R	<ul style="list-style-type: none">• Embossed tape 8 mm wide• Pin 1, 6 face the perforation side of the tape• Qty 3 kpcs/reel

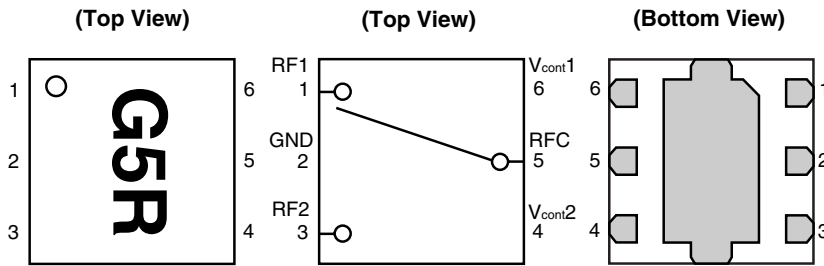
Remark To order evaluation samples, please contact your nearby sales office.

Part number for sample order: μ PG2409T6X

Caution Although this device is designed to be as robust as possible, ESD (Electrostatic Discharge) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions must be employed at all times.

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PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Pin No.	Pin Name
1	RF1
2	GND
3	RF2
4	V _{cont2}
5	RFC
6	V _{cont1}

Remark Exposed pad : GND

SW TRUTH TABLE

V _{cont1}	V _{cont2}	RFC-RF1	RFC-RF2
High	Low	ON	OFF
Low	High	OFF	ON

ABSOLUTE MAXIMUM RATINGS (T_A = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Switch Control Voltage	V _{cont}	+6.0 ^{Note}	V
Input Power	P _{in}	+36	dBm
Operating Ambient Temperature	T _A	-45 to +85	°C
Storage Temperature	T _{stg}	-55 to +150	°C

Note |V_{cont1} - V_{cont2}| ≤ 6.0 V

RECOMMENDED OPERATING RANGE (T_A = +25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Operating Frequency	f	0.05	-	6.0	GHz
Switch Control Voltage (H)	V _{cont (H)}	2.7	3.0	3.3	V
Switch Control Voltage (L)	V _{cont (L)}	-0.2	0	0.2	V
Control Voltage Difference	ΔV _{cont (H)} , ΔV _{cont (L)} ^{Note}	-0.1	0	0.1	V

Note ΔV_{cont (H)} = V_{cont1 (H)} - V_{cont2 (H)}
 ΔV_{cont (L)} = V_{cont1 (L)} - V_{cont2 (L)}

ELECTRICAL CHARACTERISTICS

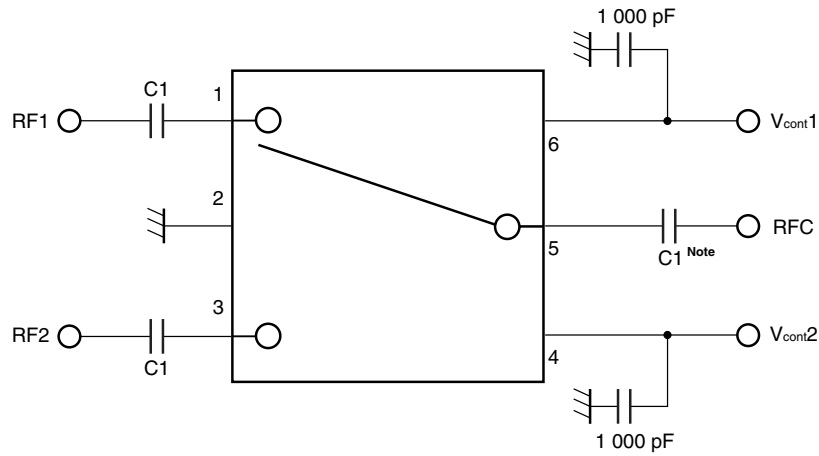
(TA = +25°C, Vcont (H) = 3.0 V, Vcont (L) = 0 V, Zo = 50 Ω, DC blocking capacitors = 8 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss 1	L _{ins1}	f = 0.05 to 0.5 GHz ^{Note 1}	–	0.35	–	dB
Insertion Loss 2	L _{ins2}	f = 0.5 to 2.0 GHz ^{Note 2}	–	0.40	0.65	dB
Insertion Loss 3	L _{ins3}	f = 2.0 to 2.5 GHz	–	0.45	0.70	dB
Insertion Loss 4	L _{ins4}	f = 2.5 to 3.8 GHz	–	0.55	0.80	dB
Insertion Loss 5	L _{ins5}	f = 3.8 to 6.0 GHz	–	0.65	0.90	dB
Isolation 1	ISL1	f = 0.05 to 0.5 GHz ^{Note 1}	–	30	–	dB
Isolation 2	ISL2	f = 0.5 to 2.0 GHz ^{Note 2}	25	30	–	dB
Isolation 3	ISL3	f = 2.0 to 2.5 GHz	25	30	–	dB
Isolation 4	ISL4	f = 2.5 to 3.8 GHz	25	30	–	dB
Isolation 5	ISL5	f = 3.8 to 6.0 GHz	22	27	–	dB
Return Loss 1	RL1	f = 0.05 to 0.5 GHz ^{Note 1}	–	20	–	dB
Return Loss 2	RL2	f = 0.5 to 2.0 GHz ^{Note 2}	15	20	–	dB
Return Loss 3	RL3	f = 2.0 to 2.5 GHz	15	20	–	dB
Return Loss 4	RL4	f = 2.5 to 6.0 GHz	10	15	–	dB
0.1 dB Loss Compression Input Power ^{Note 3}	P _{in (0.1 dB)}	f = 0.5 to 6.0 GHz ^{Note 2}	–	+34.0	–	dBm
1 dB Loss Compression Input Power ^{Note 4}	P _{in (1 dB)}	f = 0.05 to 0.5 GHz ^{Note 1}	–	+36.0	–	dBm
		f = 0.5 to 6.0 GHz ^{Note 2}	+34.0	+36.0	–	dBm
2nd Harmonics	2f ₀	f = 2.5 GHz, P _{in} = +30 dBm	–	70	–	dBc
3rd Harmonics	3f ₀	f = 2.5 GHz, P _{in} = +30 dBm	–	70	–	dBc
Input 3rd Order Intercept Point	IIP ₃	f = 2.5 GHz	–	+60	–	dBm
Switch Control Current	I _{cont}	No RF input	–	0.1	10	μA
Switch Control Speed	t _{sw}	50% CTL to 90/10% RF	–	100	250	ns

- Notes** 1. DC blocking capacitors = 1 000 pF at f = 0.05 to 0.5 GHz
- 2. DC blocking capacitors = 56 pF at f = 0.5 to 2.0 GHz
- 3. P_{in (0.1 dB)} is the measured input power level when the insertion loss increases 0.1 dB more than that of the linear range.
- 4. P_{in (1 dB)} is the measured input power level when the insertion loss increases 1 dB more than that of the linear range.

Caution It is necessary to use DC blocking capacitors with this device.

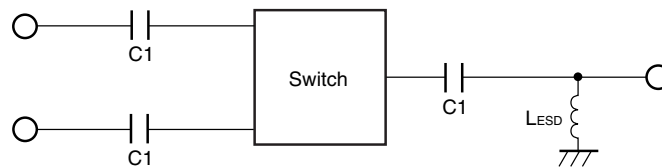
EVALUATION CIRCUIT



Note C1 : 0.05 to 0.5 GHz 1 000 pF
 : 0.5 to 2.0 GHz 56 pF
 : 2.0 to 6.0 GHz 8 pF

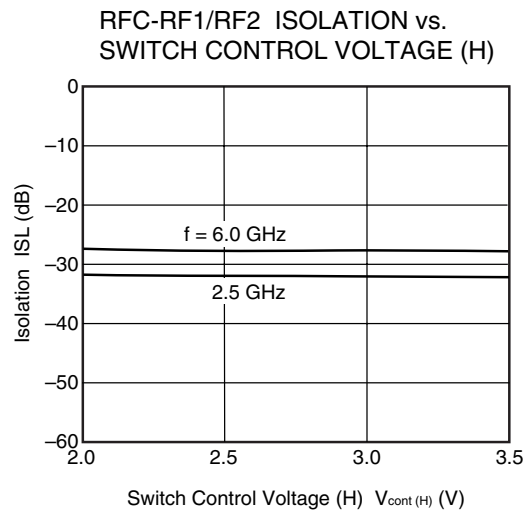
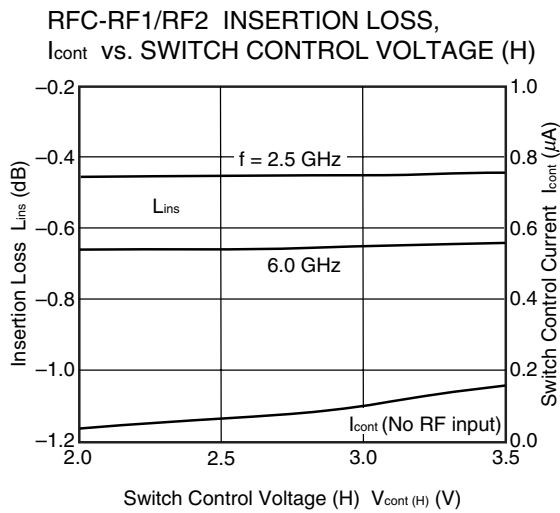
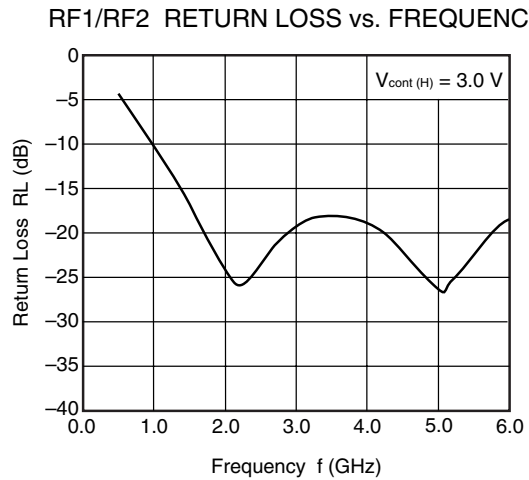
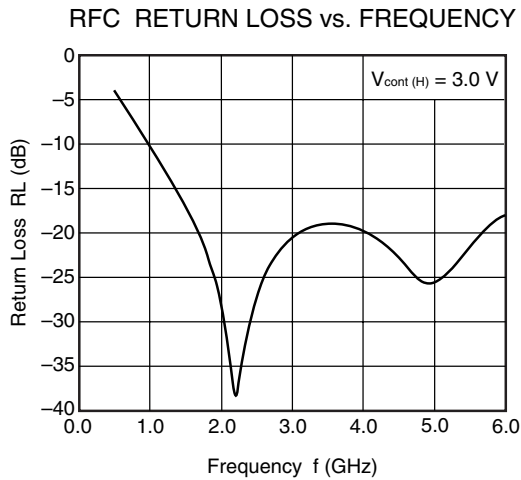
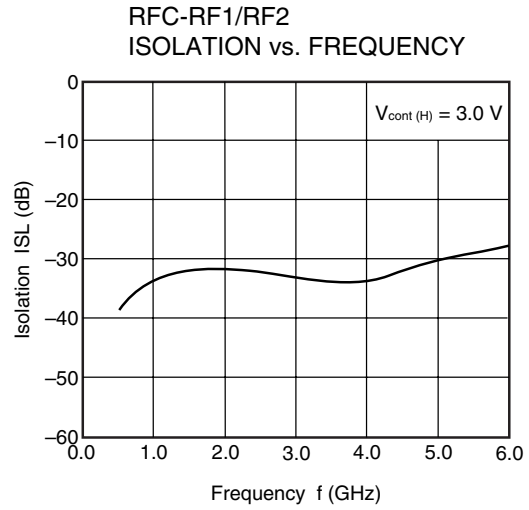
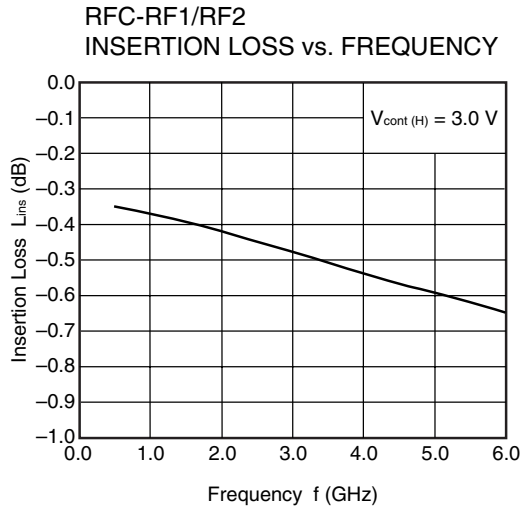
The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

APPLICATION INFORMATION

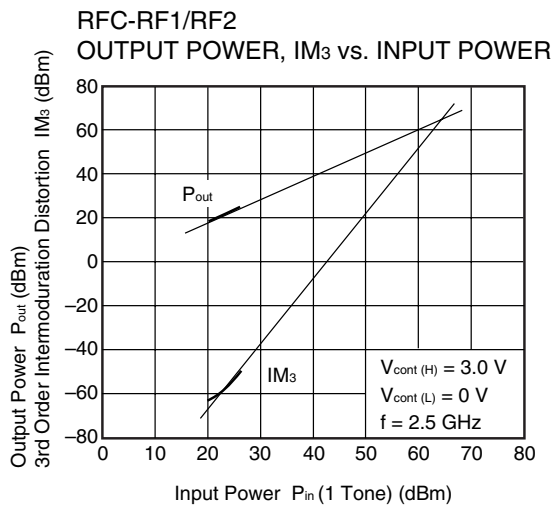
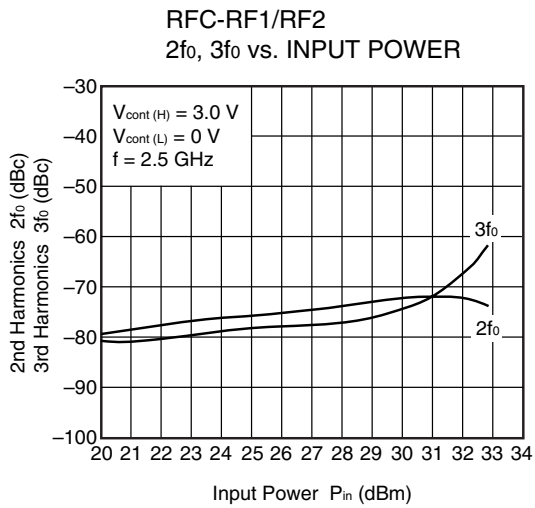
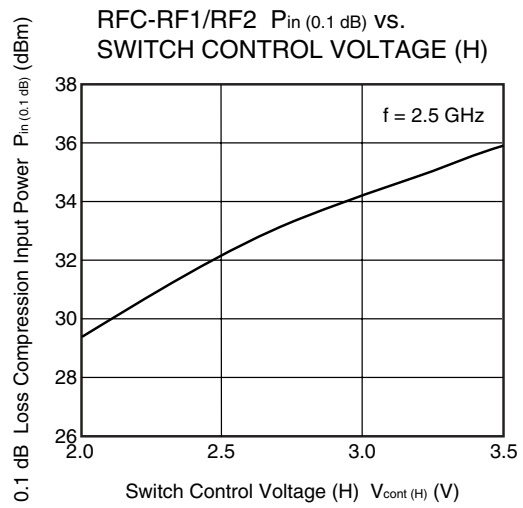
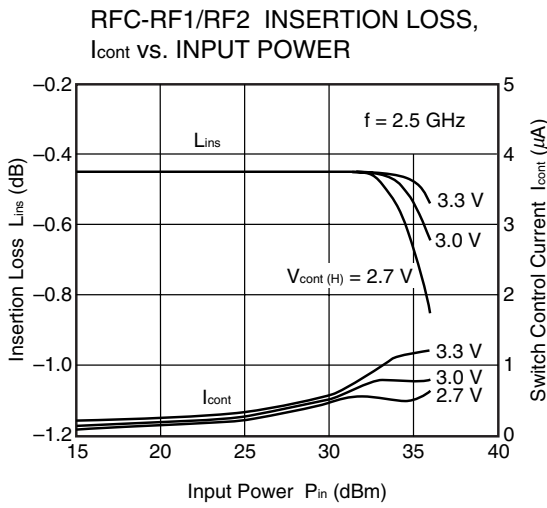
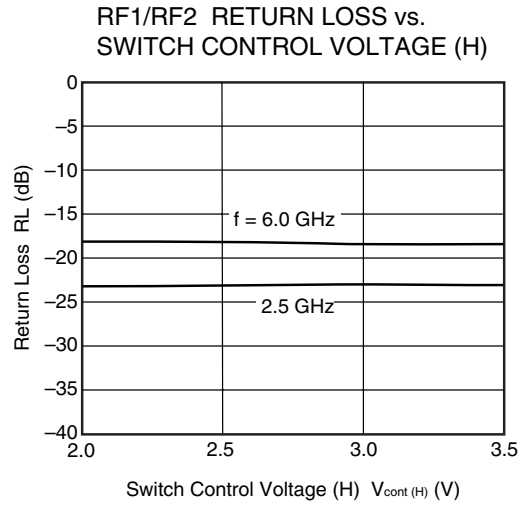
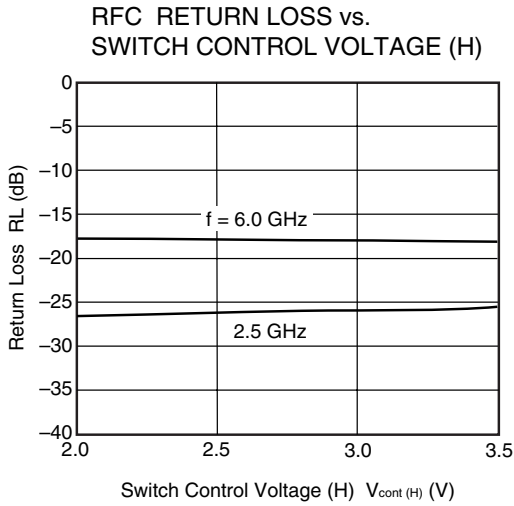


- C1 are DC blocking capacitors external to the device.
 The value may be tailored to provide specific electrical responses.
- The RF ground connections should be kept as short as possible and connected to directly to a good RF ground for best performance.
- L_{ESD} provides a means to increase the ESD protection on a specific RF port, typically the port attached to the antenna.

TYPICAL CHARACTERISTICS (T_A = +25°C, DC blocking capacitors = 8 pF, unless otherwise specified)



Remark The graphs indicate nominal characteristics.

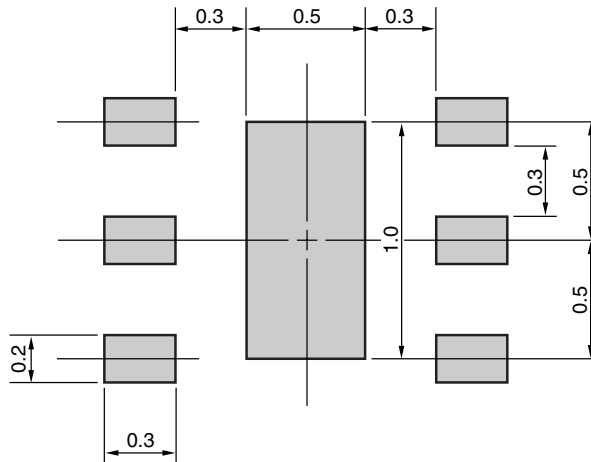


Remark The graphs indicate nominal characteristics.

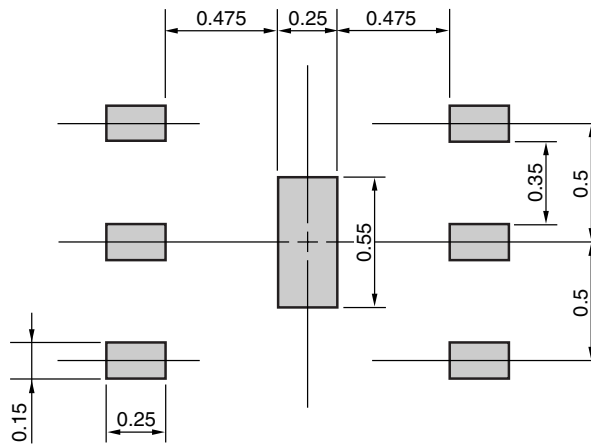
MOUNTING PAD AND SOLDER MASK LAYOUT DIMENSIONS

6-PIN PLASTIC TSON (UNIT: mm)

MOUNTING PAD



SOLDER MASK

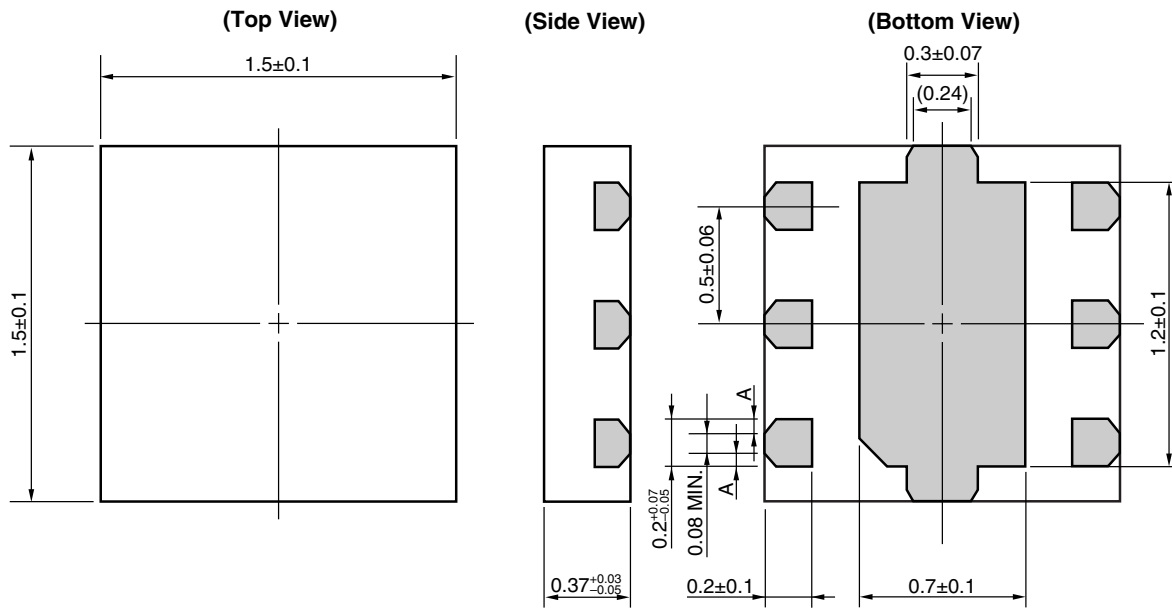


Solder thickness : 0.08 mm

Remark The mounting pad and solder mask layouts in this document is for reference only. When designing PCB, please consider workability of mounting, solder joint reliability, prevention of solder bridge and so on, in order to optimize the design.

PACKAGE DIMENSIONS

6-PIN PLASTIC TSON (T6X) (UNIT: mm)



Remark A>0

() : Reference value

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature)	: 260°C or below
	Time at peak temperature	: 10 seconds or less
	Time at temperature of 220°C or higher	: 60 seconds or less
	Preheating time at 120 to 180°C	: 120±30 seconds
	Maximum number of reflow processes	: 3 times
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below
Partial Heating	Peak temperature (terminal temperature)	: 350°C or below
	Soldering time (per side of device)	: 3 seconds or less
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below

Caution Do not use different soldering methods together (except for partial heating).

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M8E0904E

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